QUAD CORE COMPACT conga-TC370

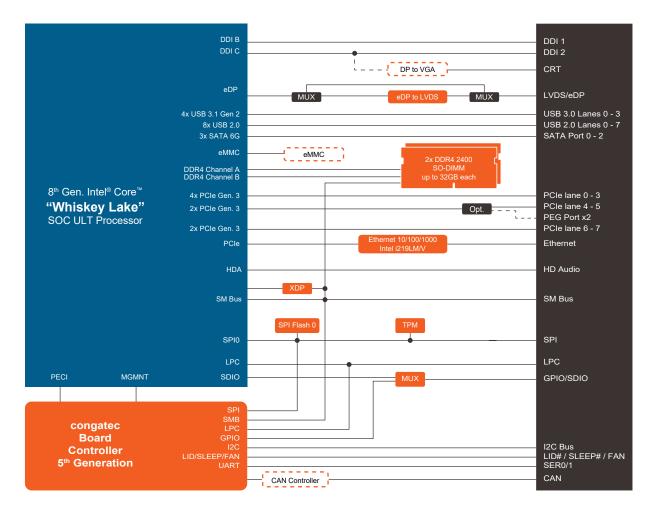


- 8th Generation Intel[®] Core[™] SOC processor up to 4 cores
- Configuration of display mode by software (LVDS/eDP)
- Low power consumption (TDP 15W, cTDP 10W)
- Up to 64 GByte dual channel DDR4 2400 MT/s
- Optional eMMC 5.1 on board mass storage
- Trusted Platform Module (TPM 2.0)
- COM Express Compact Type 6 module 95x95 mm²



| Formfactor | COM Express® Compact, (95 x 95 mm), Type 6 Connector Layout | | | | |
|---------------------------|---|--|--|--|--|
| CPU | Intel® Core™ i3-8145U 3.90 GHz (Burst) 2.1 GHz Clock Dual Core, 4 Threads L2 cache 4MB 15W TDP (configurable to 10/25W Intel® Core™ i7-8565U 4.60 GHz (Burst) 1.8 GHz Clock Quad Core, 8 Threads L2 cache 8MB 15W TDP (configurable to 10/25W | | | | |
| DRAM | Dual channel DDR4 up to 2,400 MT/s 2x SO-DIMM max. 2x 32 Gbyte | | | | |
| Chipset | Integrated Intel® 300 Series | | | | |
| Ethernet | 1x Gigabit Ethernet Intel i219LM | | | | |
| Sound | Digital High Definition Audio Interface with support for multiple audio codecs | | | | |
| Graphics | | | | | |
| Display Interface | 2x DP / HDMI or DP++ ports 18/24bit single/dual channel LVDS or eDP optional VGA interface LVDS interface with optional eDP overlay. Configuration of display mode by software | | | | |
| I/O Interfaces | 8x PCI Express Gen 3.0 lanes 3x Serial ATA Gen 3 (can be configured as RAID) 4x USB 3.1 Gen 2 8x USB 2.0 LPC bus (no DMA) I²C bus (fast mode, 400 kHz, multi-master) 2x UART | | | | |
| Storage | optional eMMC 5.1 on board mass storage | | | | |
| congatec Board Controller | | | | | |
| Embedded BIOS Features | AMI Aptio® 2.X (UEFI) BIOS SM-BIOS BIOS Update Logo Boot Quiet Boot HDD Password | | | | |
| Security | Trusted Platform Module (TPM 2.0) Secure Root of Trust Secure Memory Encryption Secure Encrypted Virtualization | | | | |
| Power Management | ACPI compliant with battery support Suspend to RAM (S3) support S5 enhanced support Intel AMT 12.0 support | | | | |
| Operating Systems | Microsoft® Windows 10 (64bit only) Microsoft® Windows 10 IoT Enterprise (64bit only) Linux | | | | |
| Power Consumption | See user's guide for full details | | | | |
| Temperature | Operating: 0 +60°C Storage: -20 +70°C | | | | |
| Humidity | Operating: 10 - 90% r. H. non cond. Storage: 5 - 95% r. H. non cond. | | | | |
| Size | 95 x 95 mm (3.74" x 3.74") | | | | |

conga-TC370 | Block diagram



conga-TC370 | Order Information

| Article | PN | Description |
|----------------------|--------|---|
| conga-TC370/i7-8565U | 048800 | COM Express Type 6 Compact module with Intel® Core™ i7-8565U quad core processor with 1.8GHz up to 4.6GHz, 8MB Intel® Smart Cache, 2400MT/s dual channel DDR4 memory interface |
| conga-TC370/i3-8145U | 048802 | COM Express Type 6 Compact module with Intel® Core™ i7-8145U dual core processor with 2.1 GHz up to 3.9GHz, 4MB Intel® Smart Cache, 2400MT/s dual channel DDR4 memory interface |

| Accessories | | |
|--|--------|---|
| conga-TEVAL | 065800 | Evaluation carrier board for Type 6 COM-Express-modules |
| conga-LDVI/EPI | 011115 | LVDS to DVI converter board for digital flat panels with onboard EEPROM |
| COM-Express-carrier-board- Socket-5 | 400007 | Connector for COM-Express carrier boards, height 5mm, packing unit 4 pieces |
| COM-Express-carrier-board- Socket-8 | 400004 | Connector for COM-Express carrier boards, height 8mm, packing unit 4 pieces |

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